

MC10102

Quad 2-Input NOR Gate

The MC10102 is a quad 2-input NOR gate. The MC10102 provides one gate with OR/NOR outputs.

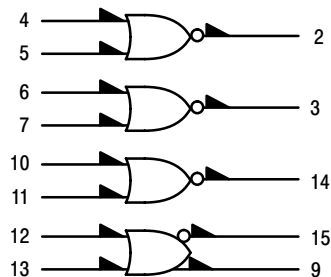
- $P_D = 25 \text{ mW typ/gate (No Load)}$
- $t_{pd} = 2.0 \text{ ns typ}$
- $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$



ON Semiconductor

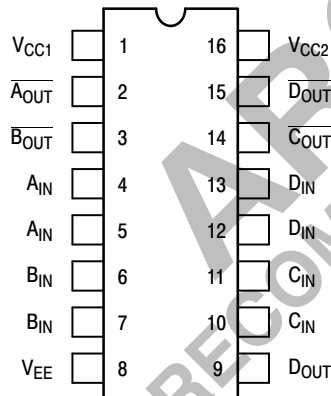
<http://onsemi.com>

LOGIC DIAGRAM



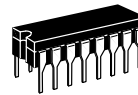
$V_{CC1} = \text{PIN 1}$
 $V_{CC2} = \text{PIN 16}$
 $V_{EE} = \text{PIN 8}$

DIP PIN ASSIGNMENT

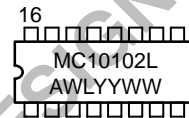


Pin assignment is for Dual-in-Line Package.
 For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

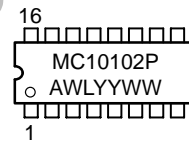
MARKING DIAGRAMS



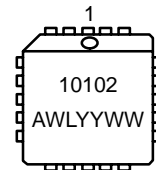
CDIP-16
L SUFFIX
CASE 620



PDIP-16
P SUFFIX
CASE 648



PLCC-20
FN SUFFIX
CASE 775



A = Assembly Location
 WL = Wafer Lot
 YY = Year
 WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10102L	CDIP-16	25 Units / Rail
MC10102P	PDIP-16	25 Units / Rail
MC10102FN	PLCC-20	46 Units / Rail

MC10102

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit	
			-30°C		+25°C			+85°C			
			Min	Max	Min	Typ	Max	Min	Max		
Power Supply Drain Current	I_E	8		29		20	26		29	mAdc	
Input Current	I_{inH}	12		425			265		265	μ Adc	
	I_{inL}	12	0.5		0.5			0.3		μ Adc	
Output Voltage Logic 1	V_{OH}	9	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700	Vdc	
		9	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
		15	-1.060	-0.890	-0.960		-0.810	-0.890	-0.700		
Output Voltage Logic 0	V_{OL}	9	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615	Vdc	
		9	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
		15	-1.890	-1.675	-1.850		-1.650	-1.825	-1.615		
Threshold Voltage Logic 1	V_{OHA}	9	-1.080		-0.980			-0.910		Vdc	
		9	-1.080		-0.980			-0.910			
		15	-1.080		-0.980			-0.910			
		15	-1.080		-0.980			-0.910			
Threshold Voltage Logic 0	V_{OLA}	9		-1.655			-1.630		-1.595	Vdc	
		9		-1.655			-1.630		-1.595		
		15		-1.655			-1.630		-1.595		
		15		-1.655			-1.630		-1.595		
Switching Times (50 Ω Load)										ns	
Propagation Delay		t_{12+15-}	15	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		t_{12-15+}	15	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		t_{12+9+}	9	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
		t_{12-9-}	9	1.0	3.1	1.0	2.0	2.9	1.0	3.3	
Rise Time (20 to 80%)		t_{15+}	15	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		t_{9+}	9	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time (20 to 80%)		t_{15-}	15	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
		t_{9-}	9	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

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ELECTRICAL CHARACTERISTICS (continued)

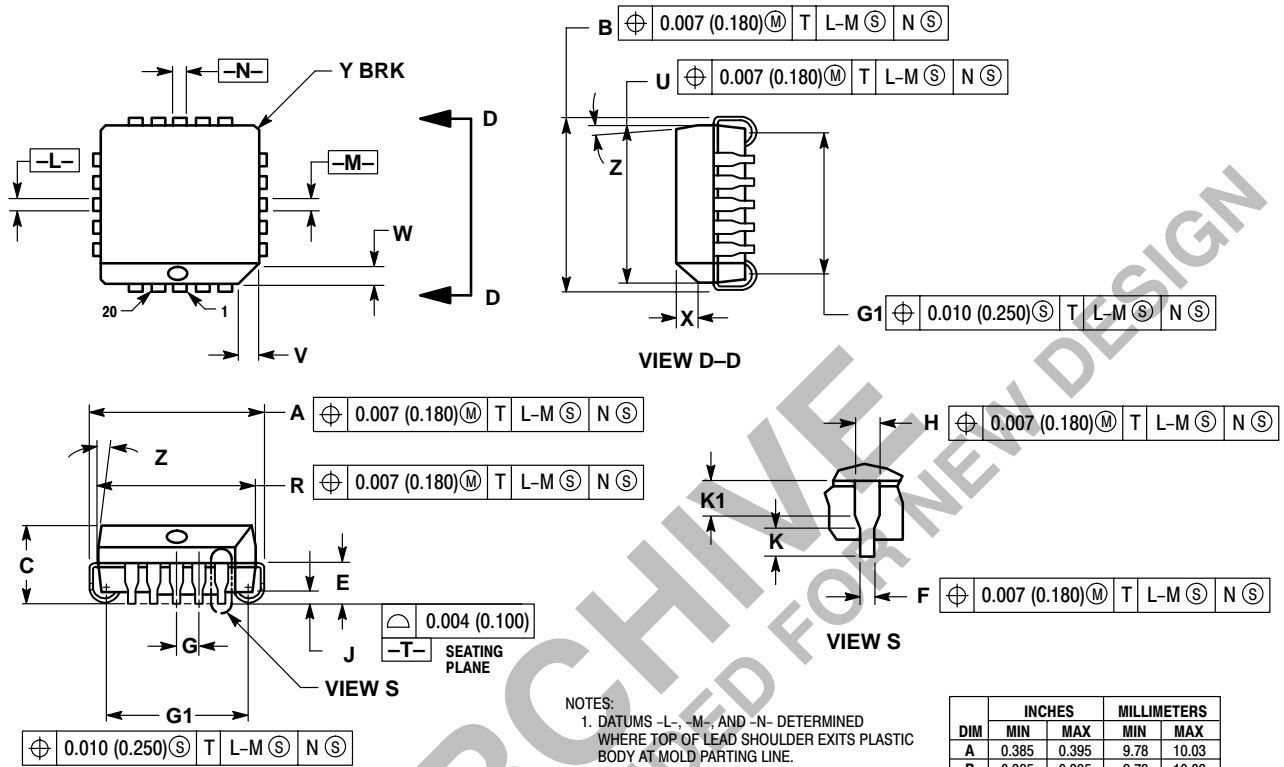
			TEST VOLTAGE VALUES (Volts)									
			V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}					
@ Test Temperature												
								-30°C				
								+25°C				
								+85°C				
			TEST VOLTAGE APPLIED TO PINS LISTED BELOW					(V _{CC}) Gnd				
Characteristic	Symbol	Pin Under Test	V _{IHmax}	V _{ILmin}	V _{IHAmin}	V _{ILAmax}	V _{EE}					
Power Supply Drain Current	I _E	8					8	1, 16				
Input Current	I _{inH}	12	12				8	1, 16				
	I _{inL}	12		12			8	1, 16				
Output Voltage	Logic 1	V _{OH}	9	12			8	1, 16				
			9	13			8	1, 16				
			15				8	1, 16				
			15				8	1, 16				
Output Voltage	Logic 0	V _{OL}	9				8	1, 16				
			9				8	1, 16				
			15	12			8	1, 16				
			15	13			8	1, 16				
Threshold Voltage	Logic 1	V _{OHA}	9		12		8	1, 16				
			9		13		8	1, 16				
			15			12	8	1, 16				
			15			13	8	1, 16				
Threshold Voltage	Logic 0	V _{OLA}	9			12	8	1, 16				
			9			13	8	1, 16				
			15		12		8	1, 16				
			15		13		8	1, 16				
Switching Times	(50Ω Load)											
Propagation Delay							Pulse In	Pulse Out	-3.2 V	+2.0 V		
							t ₁₂₊₁₅₋	15	12	15	8	1, 16
							t ₁₂₋₁₅₊	15	12	15	8	1, 16
							t ₁₂₊₉₊	9	12	9	8	1, 16
Rise Time	(20 to 80%)											
											t ₁₂₋₉₋	9
Fall Time	(20 to 80%)											
											t ₁₅₊	15
											t ₉₊	9
											t ₁₅₋	15
											t ₉₋	9

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

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PACKAGE DIMENSIONS

PLCC-20
FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775-02
ISSUE C



NOTES:

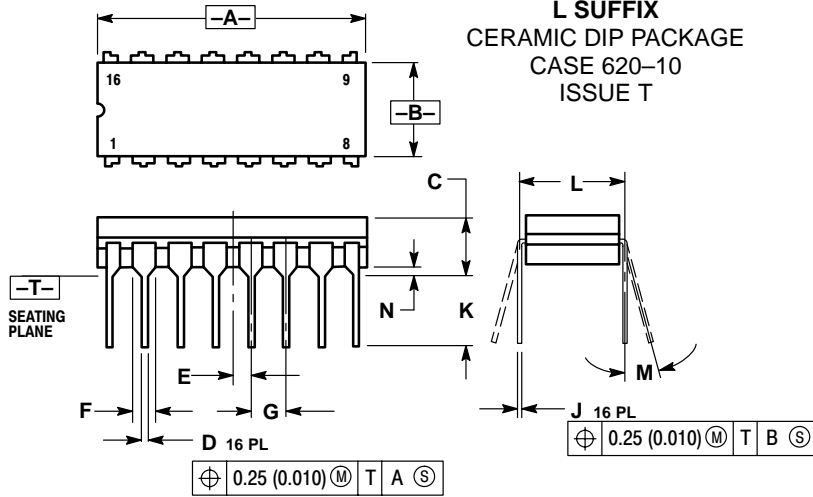
- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	---	0.51	---
K	0.025	---	0.64	---
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	---	0.020	---	0.50
Z	2°	10°	2°	10°
G1	0.310	0.330	7.88	8.38
K1	0.040	---	1.02	---

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PACKAGE DIMENSIONS

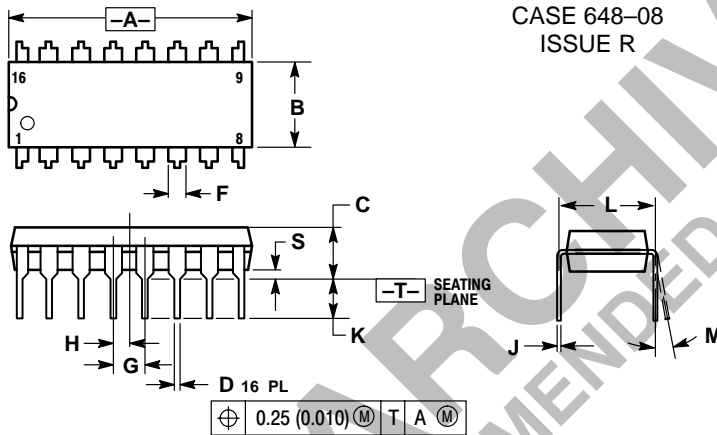
CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01


Notes

ARCHIVE
DEVICE NOT RECOMMENDED FOR NEW DESIGN

Notes

ARCHIVE
DEVICE NOT RECOMMENDED FOR NEW DESIGN

ARCHIVE
RECOMMENDED FOR NEW DESIGN

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